

8-OUTPUT LOW POWER PCIE GEN2/3 DIFFERENTIAL SYNTHESIZER
9FGL839
Description

The 9FGL839 is an 8 output differential synthesizer for PCI Express Gen1, Gen2, and Gen3 applications.

Recommended Application

100MHz PCIe Gen1/2/3 differential synthesizer

Output Features

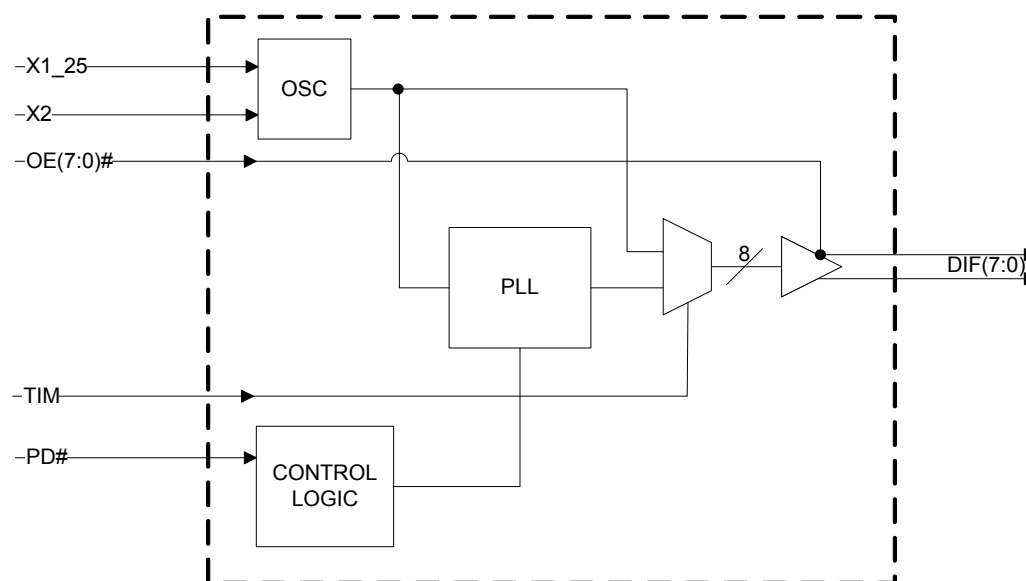
- 8 - Low Power HCSL-compatible output pairs

Features/Benefits

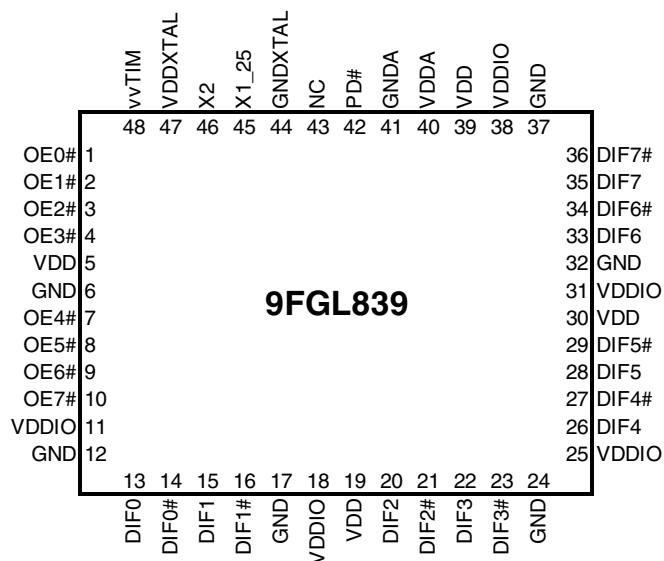
- 8 OE# pins; Hardware control of each output
- 25MHz crystal input; exact synthesis
- 100MHz operation; supports PCIe and SATA applications
- VDDIO; allows outputs to run from lower voltage rail to save power
- OE# pins have 1.5V high input threshold; direct interface to 1.8-3.3V systems

Key Specifications

- <130mW power consumption (typical)
- Cycle-to-cycle jitter <85ps
- Output-to-output skew <100 ps
- PCIe Gen2 phase jitter <3.0ps RM
- PCIe Gen3 phase jitter <1.0ps RMS

Block Diagram


Pin Configuration



48-pin MLF, 6x6 mm, 0.4mm pitch

- v prefix indicates internal 120KOhm pull down resistor
- vv prefix indicates internal 60KOhm pull down resistor
- ^ prefix indicates internal 120KOhm pull up resistor

Power Management Table

Inputs	Control Bits/Pins	Outputs	PLL State
PD#	OE# Pin	DIFx/DIFx#	
0	X	Low/Low	OFF
1	0	Running	ON
1	1	Low/Low	ON

MLF Power Connections Table

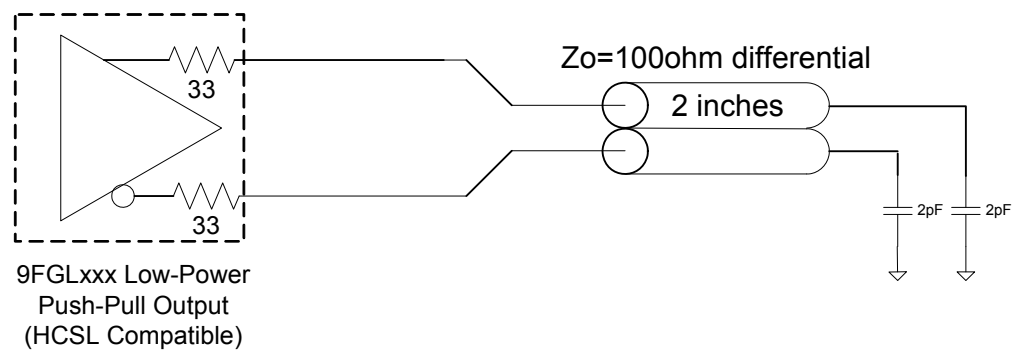
Pin Number				Description
VDDA	VDD	VDDIO	GND	
40			41	Analog PLL
47			44	XTAL
	5		6	Inputs
	19, 30, 39	11, 18, 25, 31, 38	12, 17, 24, 32, 37	DIF clocks

Pin Descriptions

PIN #	PIN NAME	TYPE	DESCRIPTION
1	OE0#	IN	Active low input for enabling DIF pair 0. 1 =disable outputs, 0 = enable outputs
2	OE1#	IN	Active low input for enabling DIF pair 1. 1 =disable outputs, 0 = enable outputs
3	OE2#	IN	Active low input for enabling DIF pair 2. 1 =disable outputs, 0 = enable outputs
4	OE3#	IN	Active low input for enabling DIF pair 3. 1 =disable outputs, 0 = enable outputs
5	VDD	PWR	Power supply, nominal 3.3V
6	GND	PWR	Ground pin.
7	OE4#	IN	Active low input for enabling DIF pair 4 1 =disable outputs, 0 = enable outputs
8	OE5#	IN	Active low input for enabling DIF pair 5. 1 =disable outputs, 0 = enable outputs
9	OE6#	IN	Active low input for enabling DIF pair 6. 1 =disable outputs, 0 = enable outputs
10	OE7#	IN	Active low input for enabling DIF pair 7. 1 =disable outputs, 0 = enable outputs
11	VDDIO	PWR	Power supply for differential outputs
12	GND	PWR	Ground pin.
13	DIF0	OUT	Differential true clock output
14	DIF0#	OUT	Differential Complementary clock output
15	DIF1	OUT	Differential true clock output
16	DIF1#	OUT	Differential Complementary clock output
17	GND	PWR	Ground pin.
18	VDDIO	PWR	Power supply for differential outputs
19	VDD	PWR	Power supply, nominal 3.3V
20	DIF2	OUT	Differential true clock output
21	DIF2#	OUT	Differential Complementary clock output
22	DIF3	OUT	Differential true clock output
23	DIF3#	OUT	Differential Complementary clock output
24	GND	PWR	Ground pin.
25	VDDIO	PWR	Power supply for differential outputs
26	DIF4	OUT	Differential true clock output
27	DIF4#	OUT	Differential Complementary clock output
28	DIF5	OUT	Differential true clock output
29	DIF5#	OUT	Differential Complementary clock output
30	VDD	PWR	Power supply, nominal 3.3V
31	VDDIO	PWR	Power supply for differential outputs
32	GND	PWR	Ground pin.
33	DIF6	OUT	Differential true clock output
34	DIF6#	OUT	Differential Complementary clock output
35	DIF7	OUT	Differential true clock output
36	DIF7#	OUT	Differential Complementary clock output
37	GND	PWR	Ground pin.
38	VDDIO	PWR	Power supply for differential outputs
39	VDD	PWR	Power supply, nominal 3.3V
40	VDDA	PWR	3.3V power for the PLL core.
41	GNDA	PWR	Ground pin for the PLL core.
42	PD#	IN	Asynchronous active low input pin used to power down the device. The internal clocks are disabled and the VCO and the crystal osc. (if any) are stopped.
43	NC	N/A	No Connection.
44	GNDXTAL	PWR	GND for XTAL
45	X1_25	IN	Crystal input, Nominally 25.00MHz.
46	X2	OUT	Crystal output.
47	VDDXTAL	PWR	Power supply for XTAL, nominal 3.3V
48	wTIM	IN	This pin is the Test Input Mode pin. A '0' on this pin puts the part in normal operating mode. A '1' on this pin puts the part in Test Input Mode, bypassing the PLL. This pin should be either pulled to ground with an external 10Kohm resistor or grounded

Test Loads

Low-Power Differential Output Test Load



Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 9FGL839. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
3.3V Core Supply Voltage	VDD, VDDA	VDD for core logic and PLL			4.6	V	1,2
IO Supply Voltage	VDDIO	VDD for differential IO			4.6	V	1,2
Input Low Voltage	V _{IL}		GND-0.5			V	1
Input High Voltage	V _{IH}	Except for SMBus interface			V _{DD} +0.5	V	1
Input High Voltage	V _{IHSMB}	SMBus clock and data pins (if present)			5.5	V	1
Storage Temperature	T _s		-65		150	°C	1
Junction Temperature	T _j				125	°C	1
Input ESD protection	ESD prot	Human Body Model	2000			V	1

¹Guaranteed by design and characterization, not 100% tested in production.

²Operation under these conditions is neither implied nor guaranteed.

Electrical Characteristics—Input/Supply/Common Parameters

T_A = T_{COM} or T_{IND}; Supply Voltage V_{DD}/V_{DDA} = 3.3 V +/-5%, VDDIO = 1.05V to 3.3V +/-5%

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Ambient Operating Temperature	T _{COM}	Commercial range	0		70	°C	1
	T _{IND}	Industrial range	-40		85	°C	1
Input High Voltage	V _{IHOE}	OE# pins	1.5		V _{DD} + 0.3	V	1
Input High Voltage	V _{IH}	Single-ended inputs, except SMBus, low threshold and tri-level inputs	2		V _{DD} + 0.3	V	1
Input Low Voltage	V _{IL}	Single-ended inputs, except SMBus, low threshold and tri-level inputs	GND - 0.3		0.8	V	1
Input Current	I _{IN}	Single-ended inputs, V _{IN} = GND, V _{IN} = VDD	-5	+/-3	5	uA	1
	I _{INP}	Single-ended inputs V _{IN} = 0 V; Inputs with internal pull-up resistors V _{IN} = VDD; Inputs with internal pull-down resistors	-200	+/-75	200	uA	1
Input Frequency	F _{in}	V _{DDA} , V _{DD}		25		MHz	2
Pin Inductance	L _{pin}			6	7	nH	1
Capacitance	C _{IN}	Logic Inputs	1.5	4	5	pF	1
	C _{OUT}	Output pin capacitance		5	6	pF	1
Clk Stabilization	T _{STAB}	From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock		0.5	1	ms	1,2
OE# Latency	t _{LATOE#}	DIF start after OE# assertion DIF stop after OE# deassertion	1	2	4	clocks	1
T _{fall}	t _F	Fall time of control inputs			10	ns	1,2
T _{rise}	t _R	Rise time of control inputs			10	ns	1,2

¹Guaranteed by design and characterization, not 100% tested in production.

²Control input must be monotonic from 20% to 80% of input swing.

³Time from deassertion until outputs are >200 mV

Electrical Characteristics–DIF 0.7V Low Power Differential Outputs

$T_A = T_{COM}$ or T_{IND} ; Supply Voltage $V_{DD}/V_{DDA} = 3.3\text{ V} \pm 5\%$, $V_{DDIO} = 1.05\text{V to } 3.3\text{V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Slew rate	T_{rf}	Scope averaging on	1		4	V/ns	1, 2, 3
Slew rate matching	ΔT_{rf}	Slew rate matching, Scope averaging on			20	%	1, 2, 4
Voltage High	V_{High}	Statistical measurement on single-ended signal using oscilloscope math function. (Scope averaging on)	500	590	850	mV	1
Voltage Low	V_{Low}		-150	9	150		1
Max Voltage	V_{max}	Measurement on single ended signal using absolute value. (Scope averaging off)		609	1150	mV	1
Min Voltage	V_{min}		-300	-19			1
Vswing	V_{swing}	Scope averaging off	300	1182		mV	1, 2
Crossing Voltage (abs)	V_{cross_abs}	Scope averaging off	250	292	550	mV	1, 5
Crossing Voltage (var)	ΔV_{cross}	Scope averaging off		23	140	mV	1, 6

¹Guaranteed by design and characterization, not 100% tested in production. $C_L = 2\text{pF}$. (100 Ω differential trace impedance).

² Measured from differential waveform

³ Slew rate is measured through the V_{swing} voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

⁴ Matching applies to rising edge rate of Clock / falling edge rate of Clock#. It is measured in a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope uses for the edge rate calculations.

⁵ V_{cross} is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

⁶ The total variation of all V_{cross} measurements in any particular system. Note that this is a subset of $V_{cross_min/max}$ (V_{cross} absolute) allowed. The intent is to limit V_{cross} induced modulation by setting V_{cross_delta} to be smaller than V_{cross_abs} .

Electrical Characteristics–Current Consumption

$T_A = T_{COM}$ or T_{IND} ; Supply Voltage $V_{DD}/V_{DDA} = 3.3\text{ V} \pm 5\%$, $V_{DDIO} = 1.05\text{V to } 3.3\text{V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Operating Current	$I_{DDVDD, VDDA}$	$C_L = 2\text{pF}$; V_{DD}/V_{DDA} rail, all outputs on		35	40	mA	1
	$I_{DDVDDIO}$	$C_L = 2\text{pF}$; V_{DDIO} rail, all outputs on		14	20	mA	1
Powerdown Current	$I_{DDVDD, VDDA}$	Power Down, V_{DD}/V_{DDA} Rail		5.3	6	mA	1
	$I_{DDVDDIO}$	Power Down, V_{DDIO} Rail		0.001	0.1	mA	1

¹Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics–Skew and Differential Jitter Parameters

$T_A = T_{COM}$ or T_{IND} ; Supply Voltage $V_{DD}/V_{DDA} = 3.3\text{ V} \pm 5\%$, $V_{DDIO} = 1.05\text{V to } 3.3\text{V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
DIF[x:0]	t_{SKEW_ALL}	Output-to-Output Skew across all outputs		56	100	ps	1,2,3
Duty Cycle	t_{DC}	Measured differentially, PLL Mode	45	49.4	55	%	1,3
Jitter, Cycle to cycle	$t_{jcy-cyc}$	PLL mode		21	85	ps	1,3,4

Notes for preceding table:

¹ Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

² Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

³ Guaranteed by design and characterization, not 100% tested in production.

⁴ Measured from differential waveform

Electrical Characteristics–Phase Jitter Parameters

$T_A = T_{COM}$ or T_{IND} ; Supply Voltage $V_{DD}/V_{DDA} = 3.3\text{ V} \pm 5\%$, $V_{DDIO} = 1.05\text{V to } 3.3\text{V} \pm 5\%$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Phase Jitter	$t_{jphPCIEG1}$	PCIe Gen 1		23	86	ps (p-p)	1,2,3
	$t_{jphPCIEG2}$	PCIe Gen 2 Lo Band $10\text{kHz} < f < 1.5\text{MHz}$		0.6	3	ps (rms)	1,2
		PCIe Gen 2 High Band $1.5\text{MHz} < f < \text{Nyquist (50MHz)}$		1.9	3.1	ps (rms)	1,2
	$t_{jphPCIEG3}$	PCIe Gen3		0.4	1	ps (rms)	1,2

¹ Applies to all outputs.

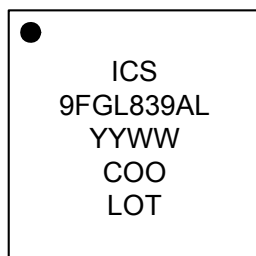
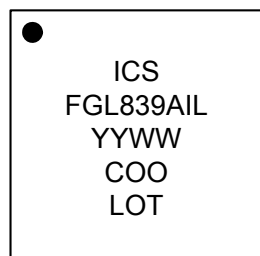
² See <http://www.pcisig.com> for complete specs

³ Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

Clock Periods–Differential Outputs

SSC OFF	Center Freq. MHz	Measurement Window							Units	Notes
		1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
		-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max		
DIF	100.00	9.91450		9.99950	10.00000	10.00050		10.08550	ns	1,2,3

Marking Diagrams



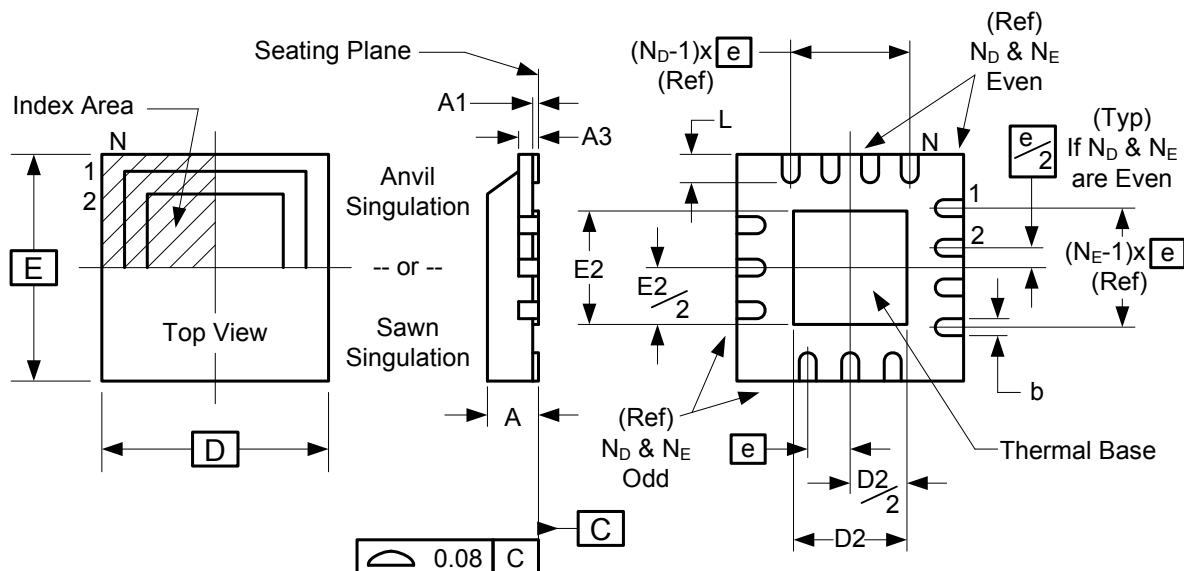
Notes:

1. "LOT" is the lot number.
2. YYWW is the last two digits of the year and week that the part was assembled.
3. "L" denotes RoHS compliant package.
4. "I" denotes industrial temperature range.
4. "COO" denotes country of origin.

Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	θ_{JA}	Still air		34		$^{\circ}\text{C/W}$
	θ_{JA}	1 m/s air flow		31		$^{\circ}\text{C/W}$
	θ_{JA}	2 m/s air flow		29		$^{\circ}\text{C/W}$
Thermal Resistance Junction to Case	θ_{JC}			31.7		$^{\circ}\text{C/W}$

Package Outline and Package Dimensions (48-pin MLF)



Symbol	Millimeters	
	Min	Max
A	0.8	1.0
A1	0	0.05
A3	0.20 Reference	
b	0.15	0.25
e	0.40 BASIC	
D x E BASIC	6.00 x 6.00	
D2 MIN./MAX.	4.10	4.30
E2 MIN./MAX.	4.10	4.30
L MIN./MAX.	0.35	0.45
N	48	
N _D	12	
N _E	12	

Ordering Information

Part / Order Number	Shipping Package	Package	IDT Package Code	Temperature
9FGL839AKLF	Trays	48-pin MLF	NDG48	0 to +70°C
9FGL839AKLFT	Tape and Reel	48-pin MLF	NDG48	0 to +70°C
9FGL839AKILF	Trays	48-pin MLF	NDG48	-40 to +85°C
9FGL839AKILFT	Tape and Reel	48-pin MLF	NDG48	-40 to +85°C

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

"A" is the device revision designator (will not correlate with the datasheet revision).

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Revision History

Rev.	Issuer	Issue Date	Description	Page #
0.1	RDW	10/6/2011	Initial Release	
A	RDW	1/6/2012	1. Updated Features/Benefits 2. Updated Power Connections Table 3. Updated Electrical Tables to Final, removed references to 125M 4. Adding mark information and Thermal Data	1,2, 5-8

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